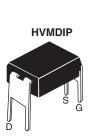
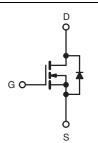
# Vishay Siliconix

COMPLIANT

# **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	100			
$R_{DS(on)}(\Omega)$	$V_{GS} = 5.0 \text{ V}$	0.54		
Q <sub>g</sub> (Max.) (nC)	6.1			
Q <sub>gs</sub> (nC)	2.6			
Q <sub>gd</sub> (nC)	3.3			
Configuration	Single			





N-Channel MOSFET

#### **FEATURES**

- · Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C Operating Temperature
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### Note

\* Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION			
Package	HVMDIP		
Lead (Pb)-free	IRLD110PbF		
Lead (FD)-liee	SiHLD110-E3		
SnPb	IRLD110		
SILL	SiHLD110		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	100	V	
Gate-Source Voltage			$V_{GS}$	± 10	1	
Continuous Drain Current	$V_{GS}$ at 5.0 V $T_A = 25$	T <sub>A</sub> = 25 °C T <sub>A</sub> = 100 °C	- I <sub>D</sub>	1.0		
Continuous Drain Current	V <sub>GS</sub> at 5.0 V	T <sub>A</sub> = 100 °C		0.70	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	8.0		
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	100	mJ	
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	1.0	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	0.13	mJ	
Maximum Power Dissipation T <sub>A</sub> = 25 °C		$P_{D}$	1.3	W		
Peak Diode Recovery dV/dtc			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for	for 10 s		300 <sup>d</sup>		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 6.4 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 5.6 A (see fig. 12).
- c.  $I_{SD} \le 5.6$  A,  $dI/dt \le 75$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.
- d. 1.6 mm from case.



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static				L	L	L		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.0	-	2.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 10 V	-	-	± 100	nA	
Zana Oata Wallana Busin Ourmant		V <sub>DS</sub> =	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	25		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA	
D : 0		V <sub>GS</sub> = 5.0 V		-	-	0.54	1	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>		I <sub>D</sub> = 0.50 A <sup>b</sup>	-	-	0.76	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	50 V, I <sub>D</sub> = 0.60 A <sup>b</sup>	1.3	-	-	S	
Dynamic				L	L	l		
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	250	-		
Output Capacitance	C <sub>oss</sub>	1	$V_{DS} = 25 \text{ V},$	-	80	-	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	0 MHz, see fig. 5	-	15	-	1 '	
Total Gate Charge	Qg			-		6.1		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 5.0 V	$I_D = 5.6 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	2.6	nC	
Gate-Drain Charge	Q <sub>qd</sub>		see lig. 6 and 15	-	-	3.3		
Turn-On Delay Time	t <sub>d(on)</sub>			-	9.3	-		
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	$V_{DD} = 50 \text{ V}, I_D = 5.6 \text{ A},$		4.7	-	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 12 \Omega$ , $R_D = 8.4 \Omega$ , see fig. $10^b$		-	16	-		
Fall Time	t <sub>f</sub>			-	17	-		
Internal Drain Inductance	L <sub>D</sub>	6 mm (0.25") 1	Between lead, 6 mm (0.25") from		4.0	-		
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	6.0	-	- nH	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym	MOSFET symbol showing the		-	1.0		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	8.0	Α	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 1.0 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	2.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			-	110	130	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 5.6  \text{A}, dI/dt = 100  \text{A/} \mu \text{s}^{\text{b}}$		-	0.50	0.65	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	v L <sub>s</sub> and	L <sub>D</sub> )	

## Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

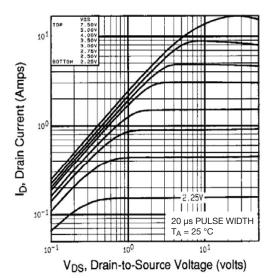


Fig. 1 - Typical Output Characteristics,  $T_A$  = 25 °C

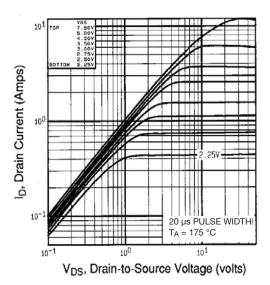


Fig. 2 - Typical Output Characteristics,  $T_A$  = 175 °C

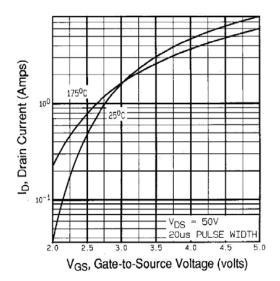


Fig. 3 - Typical Transfer Characteristics

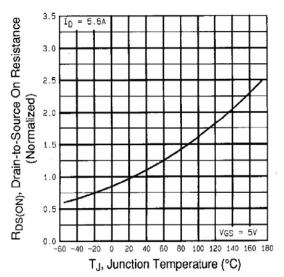


Fig. 4 - Normalized On-Resistance vs. Temperature



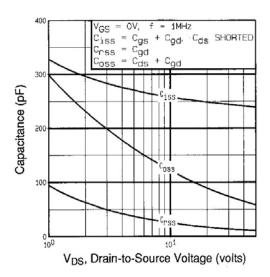


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

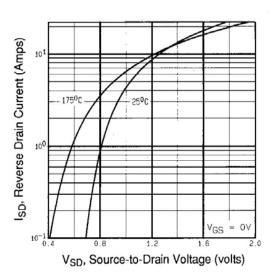


Fig. 7 - Typical Source-Drain Diode Forward Voltage

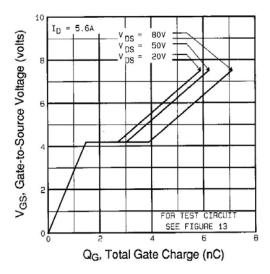


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

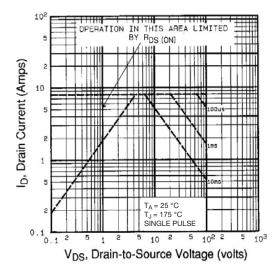


Fig. 8 - Maximum Safe Operating Area



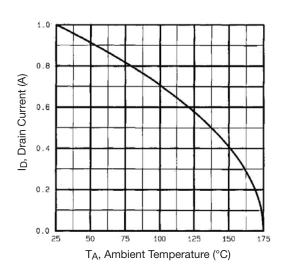


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

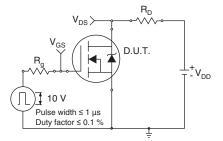


Fig. 10 - Switching Time Test Circuit

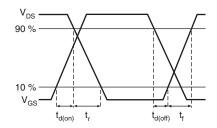


Fig. 11 - Switching Time Waveforms

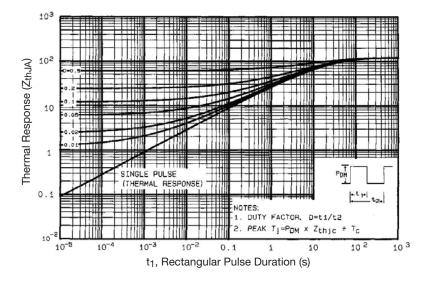


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



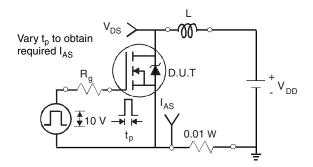


Fig. 13 - Unclamped Inductive Test Circuit

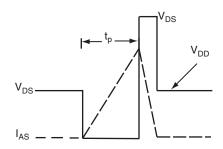


Fig. 14 - Unclamped Inductive Waveforms

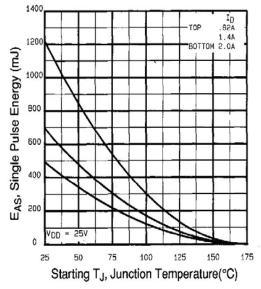


Fig. 15 - Maximum Avalanche Energy vs. Drain Current

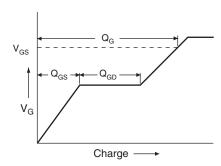


Fig. 16 - Basic Gate Charge Waveform

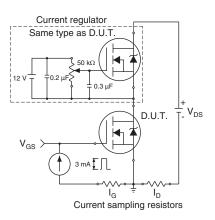
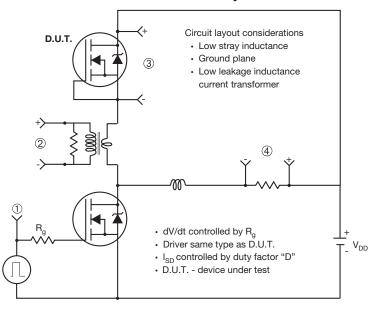


Fig. 17 - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



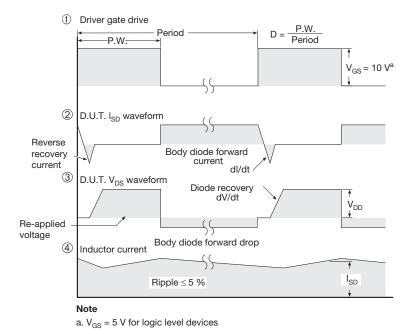
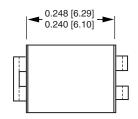


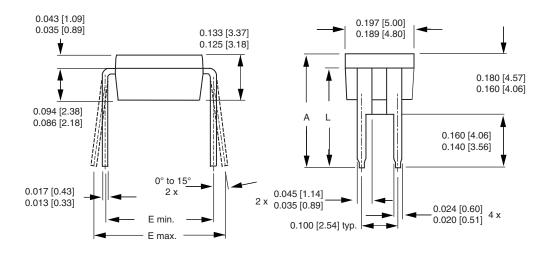
Fig. 18 - For N-Channel

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## **HVM DIP** (High voltage)





	INCHES		MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	0.310	0.330	7.87	8.38	
E	0.300	0.425	7.62	10.79	
L	0.270	0.290	6.86	7.36	

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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